

MMBT2222AT **NPN Epitaxial Silicon Transistor**

Features

- General purpose amplifier transistor.
- Ultra-Small Surface Mount Package for all types.
- · General purpose switching & amplification application



September 2008

Absolute Maximum Ratings T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	75	V
V _{CEO}	Collector-Emitter Voltage	40	V
V _{EBO}	Emitter-Base Voltage	6	V
l _C	Collector Current	600	mA
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 ~ 150	°C

These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.
These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics* Ta=25°C unless otherwise noted

Symbol	Parameter	Max	Unit
P _C	Collector Power Dissipation, by $R_{\theta JA}$	250	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	500	°C/W

Minimum land pad.

Electrical Characteristics* T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Unit
BV _{CBO}	Collector-Base Breakdown Voltage	$I_{\rm C} = 10\mu A, I_{\rm E} = 0$	75		V
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$	40		V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_{E} = 10 \mu A, I_{C} = 0$	6		V
I _{CEX}	Collector Cut-off Current	$V_{CE} = 60V, V_{EB(OFF)} = 3V$		10	nA
h _{FE}	DC Current Gain		35 50 75 100		
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_{C} = 150$ mA, $I_{B} = 15$ mA $I_{C} = 500$ mA, $I_{B} = 50$ mA		0.3 1.0	V V
V _{BE} (sat)	Base-Emitter Saturation Voltage	$I_{C} = 150$ mA, $I_{B} = 15$ mA $I_{C} = 500$ mA, $I_{B} = 50$ mA	0.6	1.2 2.0	V V
f _T	Current Gain Bandwidth Product	$V_{CE} = 20V, I_{C} = 20mA, f = 100MHz$	300		MHz
C _{ob}	Output Capacitance	$V_{CB} = 10V, I_E = 0, f = 1MHz$		8	pF
C _{ib}	Input Capacitance	$V_{EB} = 0.5V, I_{C} = 0, f = 1MHz$		30	pF
t _d	Delay Time	$V_{CC} = 30V, I_{C} = 150mA$		10	ns
t _r	Rise Time	I _{B1} =- I _{B2} = 15mA		25	ns
t _s	Storage Time	1		225	ns
t _f	Fall Time			60	ns

* DC Item are tested by Pulse Test : Pulse Width≤300us, Duty Cycle≤2%

Typical Performance Characteristics

Figure 1. DC Current Gain

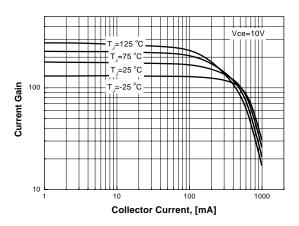
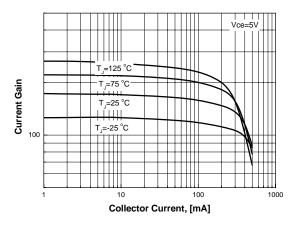
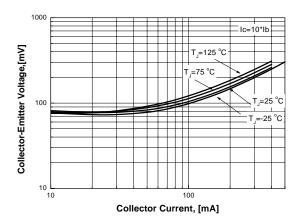


Figure 2. DC Current Gain









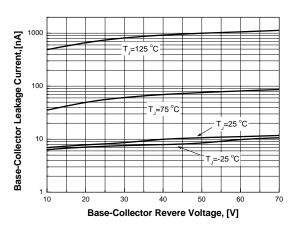


Figure 4. Base-Emitter Saturation voltage

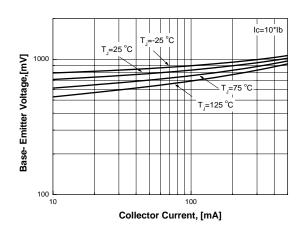
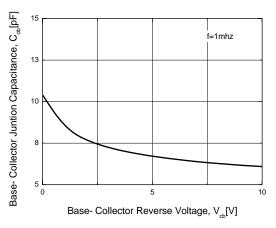
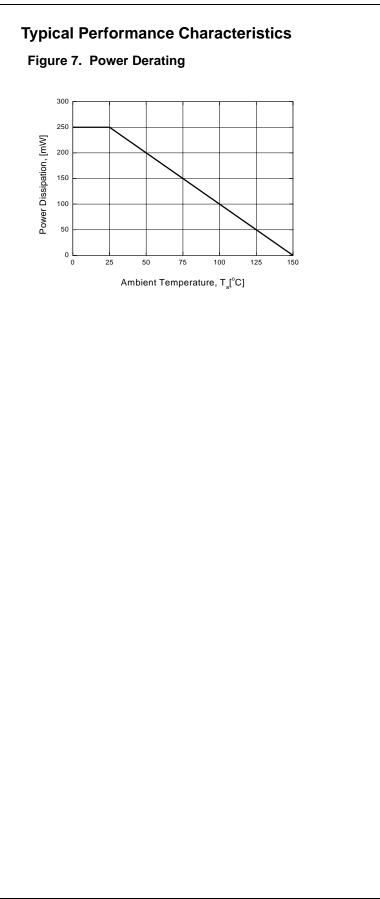
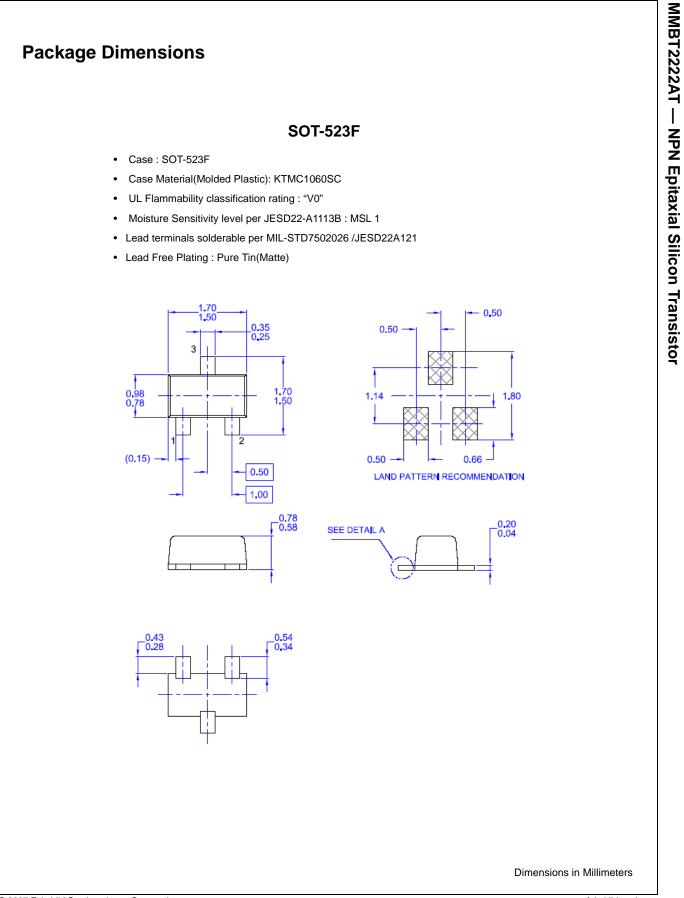


Figure 6. Collector-Base Capapcitance









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